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## Product Summary

| $\mathbf{V}_{(B R) D S S}$ | $\mathbf{R}_{\mathrm{DS}(\mathrm{ON})}$ | $\mathbf{I}_{\mathbf{D}}$ <br> $\mathbf{T}_{\mathrm{A}}=25^{\circ} \mathbf{C}$ |
| :---: | :---: | :---: |
| 60 V | $7.5 \Omega @ \mathrm{~V}_{\mathrm{GS}}=5 \mathrm{~V}$ | 115 mA |

## Description and Applications

This new generation MOSFET has been designed to minimize the onstate resistance ( $\mathrm{R}_{\mathrm{DS}(\mathrm{on})}$ ) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- DC-DC Converters
- Power management functions
- Battery Operated Systems and Solid-State Relays
- Drivers: Relays, Solenoids, Lamps, Hammers, Displays,

Memories, Transistors, etc

## Features

- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Ultra-Small Surface Mount Package
- Totally Lead Free, Full RoHS Compliant (Note 1)
- Halogen and Antimony Free. "Green" Device (Notes 2 and 3)
- Qualified to AEC-Q101 Standards for High Reliability


## Vechanical Data

- Case: SOT523
- Case Material: Molded Plastic. "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Alloy 42 leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208
- Terminal Connections: See Diagram
- Weight: 0.002 grams (approximate)
SOT523


Top View


Equivalent Circuit


Top View

## Ordering Information (Note 4)

| Part Number | Qualification | Case | Packaging |
| :---: | :---: | :---: | :---: |
| 2N7002T-7-F | Commercial | SOT523 | $3,000 /$ Tape \& Reel |
| 2N7002T-13-F | Commercial | SOT523 | $10,000 /$ Tape \& Reel |
| 2N7002TQ-7-F | Automotive | SOT523 | $3,000 /$ Tape \& Reel |
| 2N7002TQ-13-F | Automotive | SOT523 | $10,000 /$ Tape \& Reel |

Notes: 1. EU Directive 2002/95/EC (RoHS) \& 2011/65/EU (RoHS 2) compliant. No purposely added lead. Halogen and Antimony free
2. Halogen and Antimony free "Green" products are defined as those which contain $<900 \mathrm{ppm}$ bromine, $<900 \mathrm{ppm}$ chlorine ( $<1500 \mathrm{ppm}$ total $\mathrm{Br}+\mathrm{Cl}$ ) and <1000ppm antimony compounds.
3. Product manufactured with Date Code UO (week 40, 2007) and newer are built with Green Molding Compound. Product manufactured prior to Date Code UO are built with Non-Green Molding Compound and may contain Halogens or $\mathrm{Sb}_{2} \mathrm{O}_{3}$ Fire Retardants
4. For packaging details, go to our website at http://www.diodes.com.

## Marking Information



72 = Product Type Marking Code
YM = Date Code Marking
Y = Year (ex: T = 2006)
$M=$ Month (ex: $9=$ September)

| Date Code Key |  |  |  |  |  |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Year | 2005 | 2006 |  | 2007 | 2008 |  | 2009 |  | 2010 | 2011 |  | 2012 |
| Code | S |  | T | U |  | V | W |  | X | Y |  | Z |
| Month | Jan | Feb | Mar | Apr | May | Jun | Jul | Aug | Sep | Oct | Nov | Dec |
| Code | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | O | N | D |

Maximum Ratings $@ T_{\mathrm{A}}=25^{\circ} \mathrm{C}$ unless otherwise specified

| Characteristic | Symbol | Value | Units |
| :---: | :---: | :---: | :---: |
| Drain-Source Voltage | $V_{\text {DSS }}$ | 60 | V |
| Drain-Gate Voltage R ${ }_{\text {Gs }} \leq 1.0 \mathrm{M} \Omega$ | $V_{\text {DGR }}$ | 60 | V |
| Gate-Source Voltage $\begin{array}{r}\text { Continuous } \\ \text { Pulsed }\end{array}$ | $V_{\text {GSS }}$ | $\begin{aligned} & \pm 20 \\ & \pm 40 \\ & \hline \end{aligned}$ | V |
| Drain Current (Note 5) <br>  <br>  <br> Continuous @ $100^{\circ} \mathrm{C}$ <br> Pulsed | ID | $\begin{gathered} 115 \\ 73 \\ 800 \end{gathered}$ | mA |

Thermal Characteristics $@ T_{A}=25^{\circ} \mathrm{C}$ unless otherwise specified

| Characteristic | Symbol | Value | Units |
| :--- | :---: | :---: | :---: |
| Total Power Dissipation (Note 5) | $\mathrm{P}_{\mathrm{d}}$ | 150 | mW |
| Thermal Resistance, Junction to Ambient | $\mathrm{R}_{\theta J \mathrm{~A}}$ | 833 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Operating and Storage Temperature Range | $\mathrm{T}_{\mathrm{j},} \mathrm{T}_{\text {STG }}$ | -55 to +150 | ${ }^{\circ} \mathrm{C}$ |

Electrical Characteristics $@ T_{A}=25^{\circ} \mathrm{C}$ unless otherwise specified

| Characteristic | Symbol | Min | Typ | Max | Unit | Test Condition |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| OFF CHARACTERISTICS (Note 6) |  |  |  |  |  |  |
| Drain-Source Breakdown Voltage | BV ${ }_{\text {DSS }}$ | 60 | - | - | V | $\mathrm{V}_{G S}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=10 \mu \mathrm{~A}$ |
| Zero Gate Voltage Drain Current @ $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ <br>  $@ \mathrm{~T}_{\mathrm{C}}=125^{\circ} \mathrm{C}$ | Idss | - | - | $\begin{aligned} & \hline 1.0 \\ & 500 \end{aligned}$ | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{DS}}=60 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}$ |
| Gate-Body Leakage | Igss | - | - | $\pm 10$ | nA | $\mathrm{V}_{\mathrm{GS}}= \pm 20 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=0 \mathrm{~V}$ |
| ON CHARACTERISTICS (Note 6) |  |  |  |  |  |  |
| Gate Threshold Voltage | $\mathrm{VGS}_{\text {(th) }}$ | 1.0 | - | 2.0 | V | $\mathrm{V}_{\mathrm{DS}}=\mathrm{V}_{\mathrm{GS}}, \mathrm{ID}=250 \mu \mathrm{~A}$ |
| $\begin{array}{ll}\text { Static Drain-Source On-Resistance } & \\ & @ T_{j}=25^{\circ} \mathrm{C} \\ & @ T_{j}=125^{\circ} \mathrm{C}\end{array}$ | $\mathrm{R}_{\mathrm{DS}}(\mathrm{ON})$ | - | $\begin{aligned} & \hline 2.0 \\ & 4.4 \end{aligned}$ | $\begin{gathered} \hline 7.5 \\ 13.5 \end{gathered}$ | $\Omega$ | $\begin{array}{\|l} \hline V_{G S}=5.0 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=0.05 \mathrm{~A} \\ \hline \mathrm{~V}_{\mathrm{GS}}=10 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=0.5 \mathrm{~A} \\ \hline \end{array}$ |
| On-State Drain Current | $\mathrm{ld}(\mathrm{ON})$ | 0.5 | 1.0 | - | A | $\mathrm{V}_{\mathrm{GS}}=10 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=7.5 \mathrm{~V}$ |
| Forward Transconductance | g F | 80 | - | - | mS | $\mathrm{V}_{\mathrm{DS}}=10 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=0.2 \mathrm{~A}$ |
| DYNAMIC CHARACTERISTICS (Note 7) |  |  |  |  |  |  |
| Input Capacitance | $\mathrm{C}_{\text {iss }}$ | - | 22 | 50 | pF | $\mathrm{V}_{\mathrm{DS}}=25 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{f}=1.0 \mathrm{MHz}$ |
| Output Capacitance | Coss | - | 11 | 25 | pF |  |
| Reverse Transfer Capacitance | $\mathrm{C}_{\text {rss }}$ | - | 2.0 | 5.0 | pF |  |
| SWITCHING CHARACTERISTICS (Note 7) |  |  |  |  |  |  |
| Turn-On Delay Time | $\mathrm{t}_{\mathrm{D}(\mathrm{ON})}$ | - | 7.0 | 20 | ns | $\mathrm{V}_{\mathrm{DD}}=30 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=0.2 \mathrm{~A}$, |
| Turn-Off Delay Time | $\mathrm{t}_{\text {(OFF) }}$ | - | 11 | 20 | ns | $\mathrm{R}_{\mathrm{L}}=150 \Omega, \mathrm{~V}_{\mathrm{GEN}}=10 \mathrm{~V}, \mathrm{R}_{\mathrm{GEN}}=25 \Omega$ |

Notes: 5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
6 .Short duration pulse test used to minimize self-heating effect.
7. Guaranteed by design. Not subject to production testing.


Fig. 1 On-Region Characteristics


Fig. 3 Gate Threshold Variation with Temperature


Fig. 5 Typical Capacitance


Fig. 2 On-Resistance Variation with Gate Voltage and Drain-Source Current


Fig. 4 On-Resistance Variation with Temperature


Fig. 6 On-Resistance vs. Gate-Source Voltage

## Package Outline Dimensions



| SOT523 |  |  |  |
| :---: | :---: | :---: | :---: |
| Dim | Min | Max | Typ |
| A | 0.15 | 0.30 | 0.22 |
| B | 0.75 | 0.85 | 0.80 |
| C | 1.45 | 1.75 | 1.60 |
| D | - | - | 0.50 |
| G | 0.90 | 1.10 | 1.00 |
| H | 1.50 | 1.70 | 1.60 |
| J | 0.00 | 0.10 | 0.05 |
| K | 0.60 | 0.80 | 0.75 |
| L | 0.10 | 0.30 | 0.22 |
| M | 0.10 | 0.20 | 0.12 |
| $\mathbf{N}$ | 0.45 | 0.65 | 0.50 |
| $\alpha$ | $0^{\circ}$ | $8^{\circ}$ | - |
| $\mathbf{A l l}$ Dimensions in | $\mathbf{m m}$ |  |  |

## Suggested Pad Layout



| Dimensions | Value (in mm) |
| :---: | :---: |
| $\mathbf{Z}$ | 1.8 |
| $\mathbf{X}$ | 0.4 |
| $\mathbf{Y}$ | 0.51 |
| $\mathbf{C}$ | 1.3 |
| $\mathbf{E}$ | 0.7 |

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